



For use with Surface Mount packages

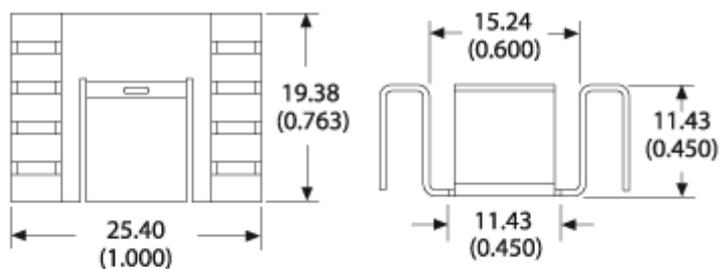
Part Number - 7109DG

RoHS 
Compliant

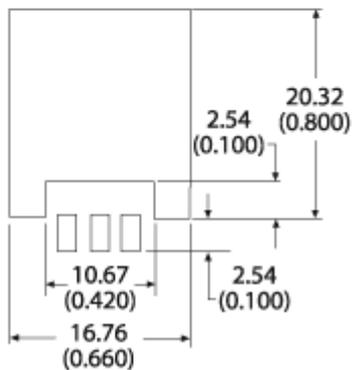
Product 
Change
Notice



Mechanical Outline Drawing



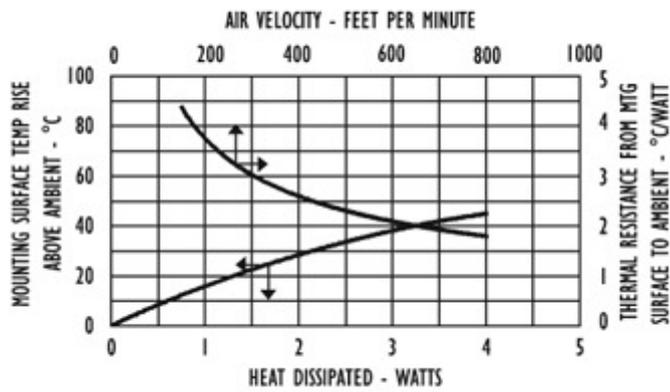
Recommended copper pad size for heat sink and device mounting footprint



Thermal Curves

Thermal Resistance	11.00
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Thermal resistance value is based on a 75°C rise in natural convection



Product Information

Packaged in tape and reel for automated assembly

[Look up tape and reel dimensions](#)

Part #	Description	Finish	Board Mounting
7109DG	Surface mount heat sink for D2 Pak (TO-263) package semiconductors	Matte Tin Plated	N/A

This non-electronic component is functionally unaffected by the normal soldering or reflow processes used for semiconductor circuits. The heat resistance time or heat resistance temperature is not applicable for the component.

Not Exactly what you need?

We offer several options for those applications which require a more unique solution. For slight modifications of this part or other attachment options, finishes, and interface materials, contact your [local representative](#). Challenge us with your thermal requirements - we can design custom solutions.

**For technical help with our Standard Products, please call (603) 224-9988, or contact your Aavid Sales Rep
Email: info@aavid.com**

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